

## C2225C391JHGACTU

Aliases (C2225C391JHGAC7800)

SMD Comm COG HV, Ceramic, 390 pF, 5%, 3,000 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 3.2 mm, 2225 / 5663



Click [here](#) for the 3D model.

### General Information

Series	SMD Comm COG HV
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
Typical Component Weight	370 mg
Shelf Life	78 Weeks
MSL	1

### Specifications

Capacitance	390 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	5%
Voltage DC	3000 VDC
Dielectric Withstanding Voltage	3,600 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

### Dimensions

L	5.6mm +/-0.4mm
W	6.4mm +/-0.4mm
T	1.6mm +/-0.20mm
S	3.2mm MIN
B	0.6mm +/-0.35mm
Case Code (EIA / mm)	2225 / 5663

### Packaging Specifications

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	1000

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